

3528 Size, 1.9mm Thickness, Leadless Chip LED





GM5UR95200A: polarity inversion type

Absolute Maximum Ratings

Model No.	Radiation color	Radiation material	P	Forward current IF	Peak forward current I_{FM} *1	Derating factor (mA/°C)		VR Topr		T _{stg}	
			(mW)	(mA)	(mA)	DC	Pulse	(V)	(°C)	(°C)	(°C)
GM5UR95200A	Red(Super-luminosity)	GaAlAs on GaAlAs	75	30	50	0.40	0.67	4	-55 to +110	-55 to +110	295
GM5HD95200A	Red	GaAsP on GaP	85	30	50	0.40	0.67	5	-55 to +110	-55 to +110	295
GM5HY95200A	Yellow	GaAsP on GaP	84	30	50	0.35	0.59	5	-55 to +110	-55 to +110	295
GM5EG95200A	Yellow-green	GaP	84	30	50	0.40	0.67	5	-55 to +110	-55 to +110	295

*1 Duty ratio=1/10, Pulse width=0.1ms

*2 For 3s or less at the temperature of hand soldering. Temperature of reflow soldering is shown on the page 7.

Electro-optical Characteristics

Lens type	Lens type Model No.		l voltage (V)	Peak emission wavelength λ _P (nm)	Luminous intensity Iv(mcd)	Spectrum radiation bandwidth $\Delta\lambda(nm)$	Reverse current Ir(µA) Vr		Terminal capacitance C _t (pF)		Page for characteristics
		TYP	MAX	TYP	TYP	TYP	MAX	MAX (V)	TYP	(MHz)	diagrams
	GM5UR95200A	1.85	2.5	660	80	20	10	4	25	1	145
Colorless	GM5HD95200A	2.0	2.8	635	13.8	35	10	4	20	1	147
transparency	GM5HY95200A	2.0	2.8	585	20	30	10	4	35	1	148
	GM5EG95200A	2.1	2.8	565	18.1	30	10	4	35	1	148

Notice

$(I_F=20mA, T_a=25^{\circ}C)$

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LED Lamp

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Note)Characteristics shown in diagrams are typical values. (not assurance value)

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E: Chip LED Device Type

Mounting to a PWB

Design the product so that the devices will not be mounted in the same direction as the warp of the PWB.



Soldering Conditions

Solder the lead pins under the following conditions.



• In manual soldering, do not move the lead pins with the soldering edge.

• Avoid applying excessive solder reinforcement.

 In using surface mount type numeric LEDs, please refer to the specification sheet because conditions shall be changed.

Not acceptable



• Do not try to correct the position of the devices after soldering.

• Do not warp PWB after soldering.



Cleaning

(1) Solvents

The package resin may be penetrated by solvents used in cleaning. Refer to the table below for usable solvents.

Solvent	Usable			
Ethyl alcohol	0			
Isopropyl alcohol	0			
Chlorosen	×			
Acetone	×			
Trichloroethylene	×			

• : Acceptable

× : Not acceptable

(Notes) • There is a world-wide movement to restrict the use of chrolofluorocarbon (CFC) based solvents and we recommend that you avoid their use. However, before using a CFC substitute solvent, carefully check that it will not penetrate the package resin.

(2) Cleaning Methods

Cleaning Method	Usable	Remarks
Solvent cleaning	0	Immersion up to one minute at room temperature
Ultrasonic cleaning		Test the cleaning under actual conditions and check for abnormalities before actual use.

○ : Acceptable

 \bigtriangleup : Acceptability depends on device type and conditions

- (Notes) The affect on the device from ultrasonic cleaning differs depending on the size of the cleaning bath, ultrasonic output, duration, board size and device mounting method. Test the cleaning method under actual conditions and check for abnormalities before actual use.
 - Please contact our representative before using a cleaning solvent or method not given above.
 - Since the device is very small, it may be damaged by excessive stress. So, pay special attention to the transport method and handling.

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■ Leadless Chip LED(Unit : mm)



LT1 90A series 3 000 pcs. / reel

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